

This is where science and industry meet to merge vision and practice on an international level.

SMART SYSTEMS INTEGRATION 2010

European Conference & Exhibition on Integration Issues of Miniaturized Systems – MEMS, MOEMS, ICs and Electronic Components

These technologies will be focused

- microsystems- und nanotechnology
- optics
- fluidics
- sensors and actuators
- chemistry and biology
- medicine
- electronics and
- wireless communication technologies

Speakers and participants from the following industries will take part

- automation
- automotive
- aerospace
- logistics
- RF
- life science
- and more...

As a conference participant at SMART SYSTEMS INTEGRATION 2010

you will benefit from

- more than 70 application oriented oral and more than 35 poster presentations
- international speakers from industry and science
- keynotes from Hitachi, Honeywell, STMicroelectronics, Sorin Group, EPoSS and the European Union
- session Organic and Printed Electronics
- special session by EPoSS
- MEMUNITY – Workshop
- networking with international experts in the conference, at the exhibition and during the social program

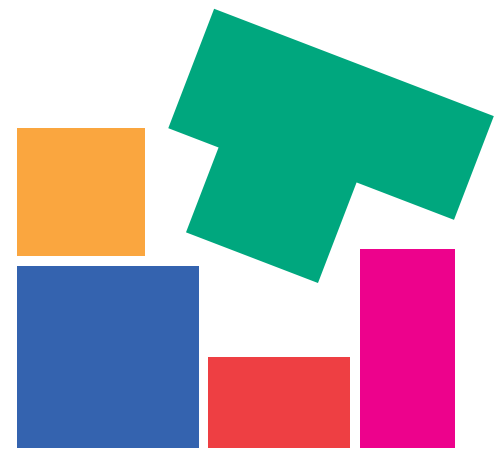
The conference topics 2010

- Smart Systems for Automotive, Aeronautics and Food Transportation
- Diagnostic and Medical Therapeutic Systems
- Power Management
- Smart Sensor-nets and Communication Devices
- Technical and Economical Trends
- Design of Smart Systems
- Micro and Nano Materials and Systems
- Advanced Micro and Nano Technologies
- Assembly and Interconnect Technologies
- System Integration and Packaging
- Reliability of Components and Systems

The special session by EPoSS, the poster presentations and the exhibition are free of charge for all participants, exhibitors and visitors.

For the detailed conference program, registration and further information please have a look at www.smartsystemsintegration.com

Early bird prices are available until 19 February 2010!



SMART SYSTEMS INTEGRATION

Como, Italy
23–24 March 2010

The Exhibition

R&D institutes, manufacturers, suppliers, service providers, producers of sub-assemblies, components and systems in the above mentioned industries and technologies look forward to talk to the expert audience.

Are you interested in exhibiting? Then order your exhibitor kit right now at www.smartsystemsintegration.com

Conference Dinner

Enjoy excellent food in the beautiful location of Villa Geno directly located at the shores of Lake Como. Network with other conference participants and speakers in a pleasant atmosphere.



Committee list

Conference Chair:

Prof. Dr. Thomas Gessner Fraunhofer ENAS Chemnitz, D

Co-Chair:

Dr. Günter Lugert Siemens AG, EPoSS, D

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A. Rydberg University of Uppsala, S
D. T. Wang Sintef, N
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Further important information

Date 23 – 24 March 2010

Venue **Spazio Villa Erba**
Largo Luchino Visconti, 4
I-22012 Cernobbio (Como)
www.villaerba.it



Headquarter Hotel **Hotel Regina Olga**
Via Regina, 18
I-22012 Cernobbio (Como)
www.hotelreginaolga.it

Special hotel rates are available until 10 February 2010.

For booking and further hotels please have a look at www.smartsystemsintegration.com

Organizer



Mesago Messe Frankfurt GmbH
Rotebuehlstr. 83 - 85
D-70178 Stuttgart

Co-Organizers



Part of the activities of



Contact: Rebecca Zondler
Phone +49 711 61946-16
smart@mesago.com
www.smartsystemsintegration.com